HEWLETT® PACKARD

HP 64700 Emulators for the Motorola 68020/68EC020 and 68030/68EC030 Processors

Technical Data

Design, Debug, and Integrate Real-time Embedded Systems

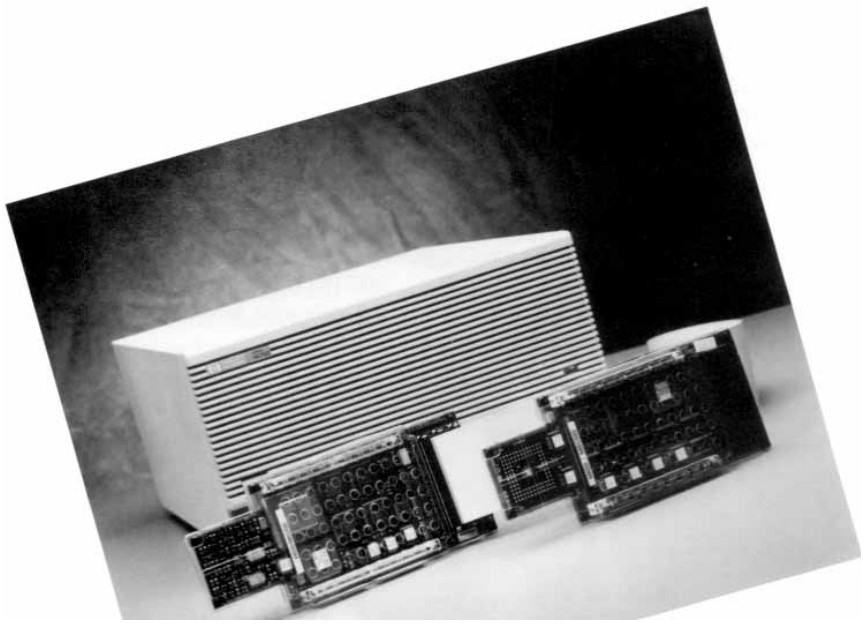
The HP 64747B emulator supports Motorola 68030 and 68EC030 microprocessors through 40 MHz operation. The HP 64748D emulator supports Motorola 68020 and 68EC020 microprocessors through 33 MHz.

The HP 64747B active probe emulator supports 68030 target systems that use the memory management unit (MMU). The 68030 MMU registers and tables are displayed and physical addresses are translated to corresponding logical addresses to link bus and program activity (DeMMYing). MMU table information can be updated automatically from the target system by user command.

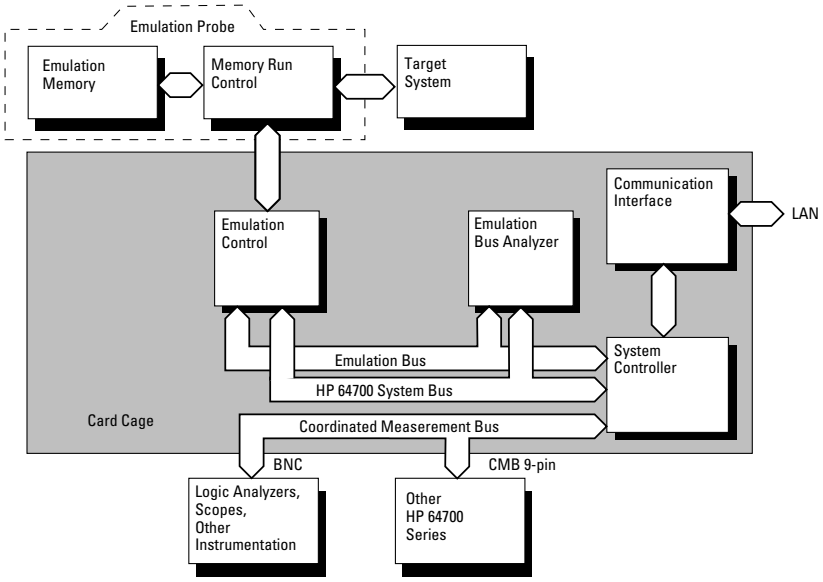
The emulators plug into the modular HP64700A card cage, which connects to your host via RS-232 or LAN. Easy-to-use interfaces are offered on IBM-compatible PCs, Sun SPARCstations, and HP 9000 Series 700 workstations. Additionally, the cardcage has firmware-resident interface can talk to any ASCII terminal.

For PC-hosted embedded development, a real-time C debugger user interface combines the ease of use of a full Microsoft Windows with HP 64700's transparent, real-time emulation. This allows you to debug embedded C programs at the source level, while your target runs at full speed.

Workstation-hosted embedded development is supported with the X/Motif-based HP graphical user interface and the Microtec Research, Inc. Xray 3.6 debugger. The environment provides easy-to-use measurement capabilities ranging from real-time, nonintrusive analysis to high-level C source code debugging.



Modular HP 64700 Series Systems



HP 64700 Series development tools include an emulator, an emulation bus analyzer, and an optional software performance analyzer (SPA).

HP 64700A Card Cage

The HP 64700A card cage is the basis for modular HP 64700 Series emulators and anlyzers. It can be disassembled and reassembled for easy, cost-saving reconfiguration to support other 8-, 16-, or 32-bit processors.

The card cage has six and a half card slots. Two and a half slots are dedicated to a card cage host control card, and an optional LAN card. The remaining four slots are available for an emulator card set, an optional software performance analyzer card and future products.

Communication with the card cage is accomplished via LAN or RD-232, allowing the HP development tools to operate in a variety of environments.

Your investments in HP emulators for Motorola 68020, 68EC020, 68030, or 68EC030 processors is protected through the modular subsystems. Each of the emulators can be reconfigured by simply changing the active probe. This modular design results in cost effective support for a variety of processors.

Bundles

HP offers a bundle for those who want to order a complete emulation system for 68xxx processor. The HP 647xxxY bundle is a convenient way to order all of the necessary components that complete an HP 64700 Series Emulator.

Each bundle contains your choice of a PC or Workstation based user interface. It includes an HP 64700B card cage, HP 64172B 1 Mbyte memory SIMM, 64794A emulation bus analyzer, HP 64748C emulation control card, and the HP 647xxx Run Control Probe.

Real-Time Emulation

The HP 64747B and HP 64748D are active probe emulators that contain the microprocessor, emulation monitor, and run control circuitry. Additionally, both a custom memory mapper chip and memory are located on the probe. As a result of this technology, the HP 64748D (68020/EC020) runs up to 33 MHz with zero wait-states out of target memory. HP 64747C (68030/EC030) runs with zero wait-states out of target memory through 25 MHz. Above 25 MHz three cycle asynchronous and synchronous accesses are supported. Burst mode accesses above 25 MHz support a 3-2-2-2 cycle pattern.

For run control, extensive breakpoint capabilities let you define where to start and stop the execution of code. Up to 32 software breakpoints can be set up in the emulator, allowing execution to be halted at an instruction point. Hardware breakpoints increase the flexibility and power of this feature, for stopping at processor address, data and status points.

Flexible memory configuration

Memory modules are used for emulation memory. Two slots are available on the active probe, allowing you to plug in the amount of memory you need up to two megabytes. If you initially order less than the maximum amount, you can easily expand your system by adding the appropriate module[s]. Modules for 256 Kbyte (HP64171A and 1 Mbyte (HP 64171B) are available and can be used in any combination with a maximum configuration of 2 Mbytes.

For the HP 64748D (68020/68EC020) there are zero wait-states out of emulation memory through 25 MHz operation. Above 25 MHz one wait-state is inserted.

Three cycles asynchronous and synchronous accesses are supported through 40 MHz operation for HP 64747B (68030/EC030). Burst mode accesses are made in 3-2-2-2 cycle pattern.

In addition to the memory modules, four kilobytes of dual-ported emulation RAM is available when the background monitor is used. The dual-ported memory allows you to display and modify critical program variables without halting the target system.

Emulation bus analysis

Dual-bus architecture provides real-time, nonintrusive analysis. This allows traces to be set up and reviewed without breaking processor execution.

Tracing microprocessor code flow is a major strength of the HP 64700 Series emulators and analyzers. Up to eight hardware resources , each consisting of addresses, data, and status event comparators can be combined in sequential trace specifications, using “find A, followed by B...” constructs up to eight levels deep. A range comparator can be applied to address or data events at any one of these levels. The analyzer will trigger and store any subsequent execution or store only specified execution information. These comprehensive resources may be combined to solve both simple and complex problems.

Precise time tagging of events helps you identify discrepancies in code execution times. Each event is logged into the analyzer with an execution time through a 16.67 MHz bus rate. Bus cycle, instruction, and module duration can be measured at 40 ns resolution.

Robust symbolic support

If your language system generates HP/MRI IEEE-695, or HP-OMF file formats and if you are using the PC or workstation interface, extensive symbolic information is available. Program symbols can be used in run control, trace specification, and storage qualification commands. Symbol information is displayed in trace and memory mnemonic displays and when you are single stepping.

If you are using C language on a workstation, source lines can be intermixed in the trace display for easy correlation between the analysis trace and original source. Source line numbers are displayed within the PC interface.

Software performance analysis

Optional software performance analysis enables you to tune and verify the time-critical aspects of your design. These capabilities are provided at both the C source and assembly language level. Through automated one-key set up, this system quickly indentifies code bottlenecks and gathers statistics and timing information that significantly reduces time and effort in optimizing code.

Probing accessories

Probing accessories are available for the active probe PGA connectors on both emulators. There are PGA-toPGA low-profile extension cables. For surface-mounted packages, there are PGA-to-PQFP adapters. To complete the PQFP connection, a PQFP dummy part replaces an active surface-mount processor and must be assembled on the target board during the surface mount process for the PQFP adapter to connect properly.

Coordinated measurements

Designs involving multiple microprocessors can be analyzed with the Coordinated Measurement Bus (CMB) for synchronized execution (start/stop) of multiple emulators. To help understand and isolate relationships between processors, up to 32 emulators and analyzers can be set up to cross trigger one another. A BNC connector included on the card cage can drive or receive a triggering of logic anlyzers, oscilloscopes, and other instrumentation.

Emulation features

68020/68EC020
(Adapter required for 68EC020)

- Support for 68020 and 68EC020
- 33 MHz active probe emulator
- Zero wait-states out of target memory.
- Zero wait-states out of emulation memory through 25 MHz (one wait-state above 25 MHz)

68030/68EC030

- Support for 68030 MMU and DeMMU Operation
- 40 MHz active probe emulator
- Supports burst and synchronous mode in target memory and emulation memory
- Supports zero wait-states out of target memory through 25 MHz. Above 25 Mhz 3 cycles accesses in async and sync modes (burst 3-2-2-2 cycles)
- Emulation memory supports 3 cycle asynchronous accesses through 40 MHz (three cycle synchronous and 3-2-2-2 burst cycle accesses through 40 MHz)
- Selective cache inhibit for block of memory (256 byte resolution)

Common features

- 36-inch probe cable terminating in active probe
- Symbolic support (with PC and workstation interface)
- 32 software breakpoints
- 8 real-time hardware breakpoints
- Background and foreground monitors (background monitor is not available while using the 68030 MMU)
- Support for IEEE-695, HP-OMF, Motorola S-Records and Extended Tek HEX file formats (symbols supported with IEEE-695 and HP-OMF)
- Mutliprocessor emulation
  - synchronous start of up to 32 emulators
  - cross triggering from another emulator, logic analyzer, or oscilloscope
- Graphical user interface (on workstations)
- Demo board and self test module

Emulation bus analyzer

- 80-channel emulation bus analyzer (HP 64794A)
- Postprocessed dequeued trace with symbols and source lines (the PC interface trace listing contains source line numbers)
- 8 events each consisting of address, status and data comparators
- Events may be sequenced 8 levels deep and can be used for complex trigger qualification and selective store.

Emulation memory

- 256 Kbyte, 512 Kbyte, 1 Mbyte, 1.25 Mbyte, and 2 Mbyte memory configurations
- Mapping resolution of 256 bytes

Easy-to-use interfaces

Easy-to-use interfaces are available in HP 9000 workstations, Sun SPARCstations, and PCs. The workstation interface can run in the X-Windows or Open Windows environment, allowing you to open several emulation and analysis windows during a session. For example, you can have a window open displaying global symbols and another window displaying trace results. Command selection is done with the click of a mouse button and the interface guides you through command completion.

On the PC, the emulation interface is windowed. Commands are selected by pressing the first letter of a command and you are guided through completion of the command syntax. Function keys can be defined as a macro to represent a sequence of commonly used commands. For trace specification, there is a window dedicated to defining events and another window dedicated to defining the search sequence. This logical partioning aids a user in defining complex measurements.

High-level debug

The high level debugger interface from Microtec Research (XRAY 3.6) can be used to control the emulator on supported workstations. This allows a designer to debug code in real time while maintaining the benefits of a source level debugger.

Full source debugging is provided for the HP 64748D and 64747B emulators by the MRI's XRAY debuggers on HP 9000 workstations and Sun SPARCstations. These debuggers support data types, stack backtrace, and stack-resident local variables. Code runs in real-time on the emulators and breakpoints are set via the debugger interface.

Specifications and Characteristics

Processor compatibility

The HP 64748D is compatible with Motorola 68020/68EC020. (HP E3400A adapter required to connect to 68EC020-based systems). HP 64747B is compatible with Motorola 68030 and 68EC030.

Electrical

Maximum clock speed

68020/68EC020: 33 MHz with no wait-states required for target system memory.

68030/EC030: supports zero wait-states out of target memory through 25 MHz. From 25 MHz to 40 Mhz, 3 cycle accesses in async and sync modes (burst 3-2-2-2 cycles).

Emulation memory speed

68020/68EC020: 25 MHz with no wait-states for emulation memory (one wirt-state above 25 Mhz).

68030/EC030: supports 3 cycle

asynchronous accesses through 40 MHz (three cycle synchronous and 3-2-2-2 burst cycle accesses through 40 MHz).

Environmental

Temperature: operating, 0° to +40°C (+32°F to +104°F); nonoperating, -40°C to +70°C (-40°F to +158°F). It is recommended that 100 LFM of airflow be provided ove the 68EC030 probe for optimum performance.

Altitude: operating , 4600 m (15 000 ft); nonoperating, 15300 m (50 000 ft.)

Relative humidity: 15% to 95%.

Regulatory Compliance

(When installed in HP 64700 cardcage)

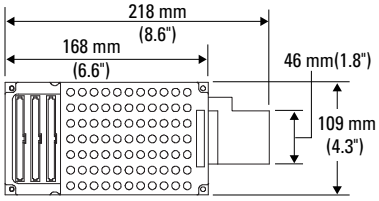
Electromagnetic interference: VDE 0871/6.78 Level A; C.I.S.P.R. 11.

Safety approvals: self-certified to UL 1244, IEC 348, CSA 22.2

Physical

Cable length: emulator to target system, approx 914 mm (36 in.).

Probe dimemsions:



Emulator AC Electrical Specifications (68020/EC020) — Read and Write Cycles

		33 MHz		
Num	**Characteristic**	**Min**	**Max**	**Unit**
6	Clock High to FC, Size, $\overline{RMC}$, Address Valid	0	21	ns
9	Clock Low to $\overline{AS}$, $\overline{DS}$, Asserted	3	20*	ns
12	Clock Low to $\overline{AS}$, $\overline{DS}$, Negated	3	20*	ns
13	$\overline{AS}$, $\overline{DS}$ Negated to FC, Size, $\overline{RMC}$, Address Invalid	0*	—	ns
17	$\overline{AS}$, $\overline{DS}$ Negated to R/$\overline{W}$ Invalid	0*	—	ns
23	Clock High to Date Out Valid	—	23*	ns
25	$\overline{AS}$, $\overline{DS}$ Negated to Date Out Invalid	2	—	ns
26	Data Out Valid to $\overline{DS}$ Asserted (Write)	5	—	ns
27	Date-In Valid to Clock Low (Synchronous Setup)	10*	—	ns
27A	Late $\overline{BERR}$, $\overline{HALT}$ Asserted to Clock Low (Setup)	10*	—	ns
31	$\overline{DSACKx}$ Asserted to Data-In Valid (Asynchronous Data Setup)	—	13*	ns
31A	$\overline{DSACKx}$ Asserted to DSACKx Valid (Skew)	—	7	ns
47A	Asynchronous Input Setup Time $\overline{HALT}$, $\overline{BERR}$, $\overline{DSACKx}$)	10*	—	ns
	Asynchronous Input Setup Time ($\overline{IPLx}$)	10*	—	ns

* Differs from chip specification

Emulator DC Electrical Specifications (68020/EC020)

Characteristic		**Symbol**	**Min**	**Max**	**Unit**
Input High Voltage		V_{IH}	2.0	V_{CC}	V
Input Low Voltage		V_{IL}	-0.5	0.8	V
Input Leakage Current	$\overline{BR}$, $\overline{BGACK}$, $\overline{IPLx}$	I_{IN}	-2.5	2.5	µA
GND≤Vin≥V_{CC}					
Input High Current	$\overline{BERR}$, $\overline{AVEC}$, $\overline{DSACKx}$	I_{IH}	—	2.5	µA
	CLK, $\overline{RESET}$, $\overline{HALT}$		—	50	
Input Low Current	$\overline{RESET}$, $\overline{HALT}$	I_{IL}	—	-1.4	mA
	CLK, $\overline{BERR}$, $\overline{AVEC}$, $\overline{DSACKx}$		—	-0.25	
Output High Voltage	A0-A31, AS, BG, D0-D31, $\overline{OBEN}$, $\overline{DS}$, $\overline{ECS}$, R/$\overline{W}$	V_{OH}	2.4	—	V
I_{OH} = -400µA	$\overline{IPEND}$, $\overline{OCS}$, $\overline{RMC}$, SIZ0-SIZ1, FC0-FC2				
Output Low Voltage		V_{OL}			V
I_{OL} = 2.5 mA	A0-A31, FC0-FC2, SIZ0-SIZ1		—	0.5	
I_{OL} = 3.2 mA	$\overline{BG}$, D0-D31		—	0.5	
I_{OL} = 4.5 mA	R/$\overline{W}$, $\overline{RMC}$		—	0.5	
I_{OL} = 5.3 mA	$\overline{AS}$, $\overline{DS}$, $\overline{OBEN}$, $\overline{IPEND}$		—	0.5	
I_{OL} = 2.0 mA	$\overline{ECS}$, $\overline{OCS}$		—	0.5	
I_{OL} = 9.3 mA	$\overline{RESET}$, $\overline{HALT}$		—	0.5	
Power Dissipation	T_A - 0°C	P_D	—	2.2	W
	T_A = 70°C		—	2.2	
Capacitance		C_{IN}	—	20	pF
V_{IN} = 0V, T_A = 25°C, f = 1 MHz					
Load Capacitance	A0-A31, FC0-FC2, SIZ0-SIZ1, R/W	C_L	—	100	p
	All Other		—	50	

Emulator AC Electrical Specifications (68030/EC030) — Read and Write Cycles

		25 MHz		40 MHz		
Num	**Characteristic**	**Min**	**Max**	**MIn**	**Max**	**Unit**
6	Clock High to FC, Size, RMC, CIOUT, Address Valid	0	20	0	14	ns
	Clock High to IPEND Valid	0	24*	0	24*	ns
6B	FC, SIZE, RMC, CIOUT, Address Valid to Negating ECS	3	—	3	—	ns
	IPEND Valid to Negating ECS	1*	—	-7*	—	ns
9	Clock Low to AS, DS, CBREQ Asserted	3	18	2	15*	ns
12	Clock Low to AS, DS, CBREQ Negated	0	18	0	15*	ns
13	AS, DS Negated to FC, Size, RMC, CIOUT, Address Invalid	6*	—	-2*	—	ns
17	AS, DS Negated to R/W Invalid	6*	—	-2*	—	ns
23	Clock High to Data Out Valid	—	20	—	19*	ns
24	Data Out Valid to Negating Edge of AS	5	—	1*	—	ns
25	AS, DS Negated to Data Out Invalid	7	—	0*	—	ns
26	Data Out Valid to DS Asserted (Write)	7	—	1*	—	ns
27	Data-In Valid to Clock Low (Synchronous Setup)	6*	—	6*	—	ns
27A	Late BERR, HALT Asserted to Clock Low (Setup)	8*	—	8*	—	ns
31	DSACKx Asserted to Data-In Valid (Asynchronous Data Setup)	—	28	—	12*	ns
31A	DSACKx Asserted to DSACKx Valid (Skew)	—	7	—	1*	ns
47A	Asynchronous Input Setup Time (HALT, BERR, DSACKx)	7*	—	7*	—	ns
	Asynchronous Input Setup (IPLx)	12*	—	12*	—	ns
60	Synchronous Input Valid to Clock High (Setup Time)	4*	—	4*	—	ns

* Differs from chip specification

Emulator DC Electrical Specifications (68030/EC030)

Characteristic		**Symbol**	**Min**	**Max**	**Unit**
Input High Voltage		V_{IH}	2.0	V_{CC}	V
Input Low Voltage		V_{IL}	-0.5	0.8	V
Input Leakage Current	BR, BGACK, IPLx, CDIS	I_{IN}	-2.5	2.5	µA
GND≤Vin≥V_{CC}					
Input High Current	CBACK, CIIM, STERM	I_{IH}	—	0	µA
	BERR, AVEC, DSACKx, HALT, MMUDIS		—	25	
	CLK, RESET		—	50	
Input Low Current	RESET, CBACK, CIIN, STERM	I_{IL}	—	-1.4	mA
	CLK, BERR, AVEC, DSACKx, HALT, MMUDIS		—	-0.25	
Output High Voltage	A0-A31, AS, BG, D0-D31, OBEN, DS, ECS,	V_{OH}	2.4	—	V
I_{OH} = -400µA	R/W, STATUS, REFILL, IPEND, OCS, RMC		2.4	—	
Output Low Voltage		V_{OL}			V
I_{OL} = 2.5 mA	A0-A31, FC0-FC2, SIZ0-SIZ1		—	0.5	
I_{OL} = 3.2 mA	BG, D0-D31		—	0.5	
I_{OL} = 4.5 mA	R/W, RMC		—	0.5	
I_{OL} = 5.3 mA	AS, DS, OBEN, IPEND		—	0.5	
I_{OL} = 2.0 mA	STATUS, REFILL, CBREQ, CIOUT, ECS, OCS		—	0.5	
I_{OL} = 9.3 mA	RESET		—	0.5	
Power Dissipation	T_A = 0°C	P_D	—	3.4	W
Capacitance		C_{IN}	—	20	pF
V_{IN} = 0V, T_A = 25°C, f = 1 MHz					
Load Capacitance	A0-A31, FC0-FC2, SIZ0-SIZ1, R/W, CBREQ, CIOUT	C_L	—	100	p
	All Other		—	50	

Ordering Information

Terminal-Based Emulation System

Model	Description
64748D	68020/68EC020 Active probe emulator (HP E3400A adapter required to connect to 68EC020 PGA-based systems)
64747B	68030/EC030 Active probe emulator
64748C	Emulation control card
64700B	Card Cage
64794A	80-channel Emulation bus analyzer card

Emulation System Options

64171A	256 Kbyte 35 ns SRAM Memory Module
64171B	1 Mbyte 35ns SRAM Memory Module
64172S	256 Kbyte 20 ns SRAM Memory Module
64172B	1 Mbyte 20ns SRAM Memory Module
64708A	Software performance analyzer card, (HP B1487A software required) (supported on HP 9000 Series workstations and Sun SPARCstations)
64023A	CMB cable (4m long; includes three 9-pin connectors)
64747SY	68030/EC030 Emulation Subsystem
64748SY	68020/EC020 Emulation Subsystem

Software for PCs

B3622A	68020/EC020 User interface
UDY	IBM single user license
ABJ	Japan, Japanese localization
B3625A	68030/EC030 User interface
UDY	IBM, single user license
ABJ	Japan, Japanese localization

Software for Workstations

For each software model number ordered, purchase one CD and one license option.

B1487A	Software performance analyzer (requires HP 64708A analyzer card)
B1475B	68020/EC020 Graphical user interface
Options	
UBY	HP 9000 series 700 single user license
UBK	Sun SPARCstation single user license
B1479B	68030/EC030 Graphical user interface
Options	
UBY	HP 9000 series 700 single user license
UBK	Sun SPARCstation single user license

Adapters/Extenders/Rotators

Model	Description
E3400A	68020 PGA to 68EC020 PGA adapter
E3401A	68020 PGA to 68EC020 PQFP adapter (includes HP P/N 64748-87607 SMT adapter)
E3403A	68020 PGA to PGA flexible cable extender
E3404A	68020 PGA to 68020 PQFP adapter (includes HP P/N 64748-87608 inactive mechanical sample)
E3405A	68030/EC030 PGA to PGA flexible cable extender
E3406A	68030/EC030 PGA to 68030/EC030 PQFP adapter (includes HP P/N 64748-87608 inactive mechanical sample)

HP P/N	Description

64748-87608 Inactive Mechanical Sample
(this is an inactive 132 pin PQFP processor package that replaces the target system processor, two per package)

64748-87607 Additional SMT Adapter for E3401A

Note: The inactive mechanical sample is supplied with the E3404A and E3406 PGA to PQFP adapters. The sample should be assembled on the target board during the surface mount process for the PQFP adapter to connect properly.

Software Support

HP provides software upgrades through the purchase of the software materials Subscription (SMS) service. Contact your HP field engineer for more information.

* Contact your HP 64000 Field Engineer for the latest configuration information, supported processor speeds, QFP adapter availability, and software options.

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For more information about Hewlett-Packard test & measurement products, applications, services, and for a current sales office listing, visit our web sites,
http://www.hp.com/go/tmdir
http://www.hp.com/go/emulator
http://www.hp.com/go/logicanalyzer
You can also contact one of the following centers and ask for a test and measurement sales representative.

United States:
Hewlett-Packard Company
Test and Measurement Call Center
P.O. Box 4026
Englewood, CO 80155-4026
1 800 452 4844

Canada:
Hewlett-Packard Canada Ltd.
5150 Spectrum Way
Mississauga, Ontario
L4W 5G1
(905) 206 4725

Europe:
Hewlett-Packard
European Marketing Centre
P.O. Box 999
1180 AZ Amstelveen
The Netherlands
(31 20) 547 9900

Japan:
Hewlett-Packard Japan Ltd.
Measurement Assistance Center
9-1, Takakura-Cho, Hachioji-Shi,
Tokyo 192, Japan
Tel: (81-426) 56-7832
Fax: (81-426) 56-7840

Latin America:
Hewlett-Packard
Latin American Region Headquarters
5200 Blue Lagoon Drive
9th Floor
Miami, Florida 33126
U.S.A.
(305) 267 4245/4220

Australia/New Zealand:
Hewlett-Packard Australia Ltd.
31-41 Joseph Street
Blackburn, Victoria 3130
Australia
1 800 629 485

Asia Pacific:
Hewlett-Packard Asia Pacific Ltd
17-21/F Shell Tower, Times Square,
1 Matheson Street, Causeway Bay,
Hong Kong
Tel: (852) 2599 7777
Fax: (852) 2506 9285

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